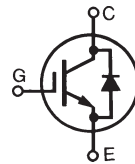


# High Voltage, High Gain BIMOSFET™ Monolithic Bipolar MOS Transistor

## IXBX25N250



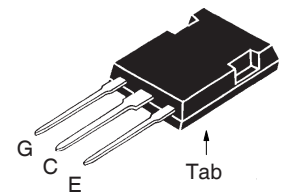
$$V_{CES} = 2500V$$

$$I_{C90} = 25A$$

$$V_{CE(sat)} \leq 3.3V$$

| Symbol         | Test Conditions   | Maximum Ratings     |            |
|----------------|---|---------------------|------------|
| $V_{CES}$      | $T_C = 25^\circ C$ to $150^\circ C$                         | 2500                | V          |
| $V_{CGR}$      | $T_J = 25^\circ C$ to $150^\circ C$ , $R_{GE} = 1M\Omega$   | 2500                | V          |
| $V_{GES}$      | Continuous  | $\pm 20$            | V          |
| $V_{GEM}$      | Transient   | $\pm 30$            | V          |
| $I_{C25}$      | $T_C = 25^\circ C$  | 55                  | A          |
| $I_{C90}$      | $T_C = 90^\circ C$  | 25                  | A          |
| $I_{CM}$       | $T_C = 25^\circ C$ , 1ms                                    | 180                 | A          |
| <b>SSOA</b>    | $V_{GE} = 15V$ , $T_{VJ} = 125^\circ C$ , $R_G = 4.7\Omega$ | $I_{CM} = 80$       | A          |
| <b>(RBSOA)</b> | Clamped Inductive Load                                      | $V_{CES} \leq 2000$ | V          |
| $P_C$          | $T_C = 25^\circ C$  | 300                 | W          |
| $T_J$          |   | -55 ... +150        | $^\circ C$ |
| $T_{JM}$       |   | 150                 | $^\circ C$ |
| $T_{stg}$      |   | -55 ... +150        | $^\circ C$ |
| $T_L$          | 1.6mm (0.062 in.) From Case for 10s                         | 300                 | $^\circ C$ |
| $T_{SOLD}$     | Plastic Body for 10 seconds                                 | 260                 | $^\circ C$ |
| $F_C$          | Mounting Force  | 20..120 / 4.5..27   | N/lb.      |
| <b>Weight</b>  |   | 6                   | g          |

### PLUS247™



G = Gate                      E = Emitter  
C = Collector                Tab = Collector

### Features

- High Blocking Voltage
- International Standard Package
- Low Conduction Losses

### Advantages

- Low Gate Drive Requirement
- High Power Density

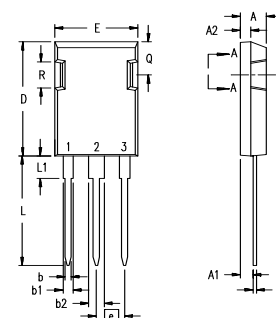
### Applications

- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies (UPS)
- Laser Generator
- Capacitor Discharge Circuit
- AC Switches

| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ Unless Otherwise Specified) | Characteristic Values |      |                    |
|---------------|---|-----------------------|------|--------------------|
|               |   | Min.                  | Typ. | Max.               |
| $BV_{CES}$    | $I_C = 250\mu A$ , $V_{GE} = 0V$                                    | 2500                  |      | V                  |
| $V_{GE(th)}$  | $I_C = 250\mu A$ , $V_{CE} = V_{GE}$                                | 2.5                   |      | 5.0 V              |
| $I_{CES}$     | $V_{CE} = 0.8 \cdot V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 125^\circ C$ |                       |      | 50 $\mu A$<br>3 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                  |                       |      | $\pm 100$ nA       |
| $V_{CE(sat)}$ | $I_C = I_{C90}$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 125^\circ C$    |                       | 3.4  | 3.3 V<br>V         |

| Symbol Test Conditions                             |  | Characteristic Values                          |      |           |
|--|--|--|------|-----------|
| (T <sub>J</sub> = 25°C Unless Otherwise Specified) |  | Min.   | Typ. | Max.      |
| <b>g<sub>fs</sub></b>                              | I <sub>C</sub> = 25A, V <sub>CE</sub> = 10V, Note 1                  | 11   | 18   | S         |
| <b>C<sub>ies</sub></b>                             | V <sub>CE</sub> = 25V, V <sub>GE</sub> = 0V, f = 1MHz                |  | 2450 | pF        |
| <b>C<sub>oes</sub></b>                             |  |  | 96   | pF        |
| <b>C<sub>res</sub></b>                             |  |  | 35   | pF        |
| <b>Q<sub>g</sub></b>                               | I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V, V <sub>CE</sub> = 1000V |  | 103  | nC        |
| <b>Q<sub>ge</sub></b>                              |  |  | 17   | nC        |
| <b>Q<sub>gc</sub></b>                              |  |  | 43   | nC        |
| <b>t<sub>d(on)</sub></b>                           | <b>Resistive Switching times, T<sub>J</sub> = 25°C</b>               |  | 55   | ns        |
| <b>t<sub>r</sub></b>                               |  | I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V    | 240  | ns        |
| <b>t<sub>d(off)</sub></b>                          |  | V <sub>CE</sub> = 1250V, R <sub>G</sub> = 4.7Ω | 145  | ns        |
| <b>t<sub>f</sub></b>                               |  |  | 640  | ns        |
| <b>t<sub>d(on)</sub></b>                           | <b>Resistive Switching times, T<sub>J</sub> = 125°C</b>              |  | 54   | ns        |
| <b>t<sub>r</sub></b>                               |  | I <sub>C</sub> = 25A, V <sub>GE</sub> = 15V    | 640  | ns        |
| <b>t<sub>d(off)</sub></b>                          |  | V <sub>CE</sub> = 1250V, R <sub>G</sub> = 4.7Ω | 140  | ns        |
| <b>t<sub>f</sub></b>                               |  |  | 510  | ns        |
| <b>R<sub>thJC</sub></b>                            |  |  |      | 0.42 °C/W |
| <b>R<sub>thCS</sub></b>                            |  | 0.15   |      | °C/W      |

### PLUS 247™ (IXBX) Outline



Terminals: 1 - Gate  
2 - Collector  
3 - Emitter

| Dim.           | Millimeter |       | Inches   |       |
|----------------|------------|-------|----------|-------|
|                | Min.       | Max.  | Min.     | Max.  |
| A              | 4.83       | 5.21  | .190     | .205  |
| A <sub>1</sub> | 2.29       | 2.54  | .090     | .100  |
| A <sub>2</sub> | 1.91       | 2.16  | .075     | .085  |
| b              | 1.14       | 1.40  | .045     | .055  |
| b <sub>1</sub> | 1.91       | 2.13  | .075     | .084  |
| b <sub>2</sub> | 2.92       | 3.12  | .115     | .123  |
| C              | 0.61       | 0.80  | .024     | .031  |
| D              | 20.80      | 21.34 | .819     | .840  |
| E              | 15.75      | 16.13 | .620     | .635  |
| e              | 5.45 BSC   |       | .215 BSC |       |
| L              | 19.81      | 20.32 | .780     | .800  |
| L1             | 3.81       | 4.32  | .150     | .170  |
| Q              | 5.59       | 6.20  | .220     | 0.244 |
| R              | 4.32       | 4.83  | .170     | .190  |

### Reverse Diode

| Symbol Test Conditions                             |  | Characteristic Values                       |      |       |
|--|--|---|------|-------|
| (T <sub>J</sub> = 25°C Unless Otherwise Specified) |  | Min.  | Typ. | Max.  |
| <b>V<sub>F</sub></b>                               | I <sub>F</sub> = 25A, V <sub>GE</sub> = 0V           |   |      | 2.3 V |
| <b>t<sub>rr</sub></b>                              | I <sub>F</sub> = 25A, -di <sub>F</sub> /dt = 100A/μs |   | 1.6  | μs    |
| <b>I<sub>RM</sub></b>                              |  | V <sub>R</sub> = 100V, V <sub>GE</sub> = 0V |      | 37.2  |

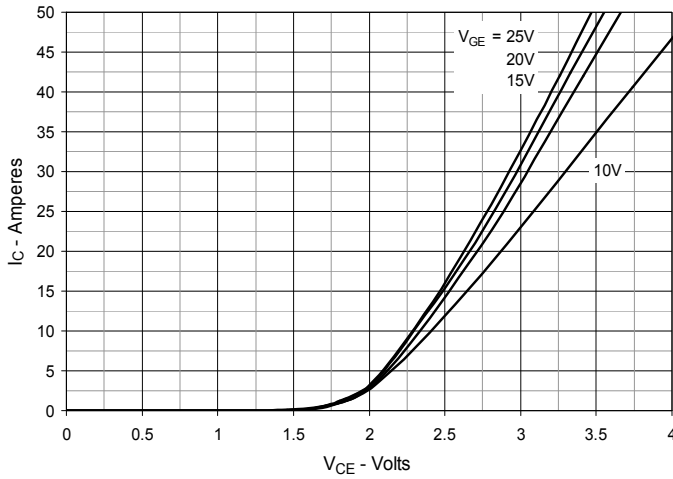
Note 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.

\*Additional provisions for lead to lead voltage isolation are required at V<sub>DS</sub> > 1200V.

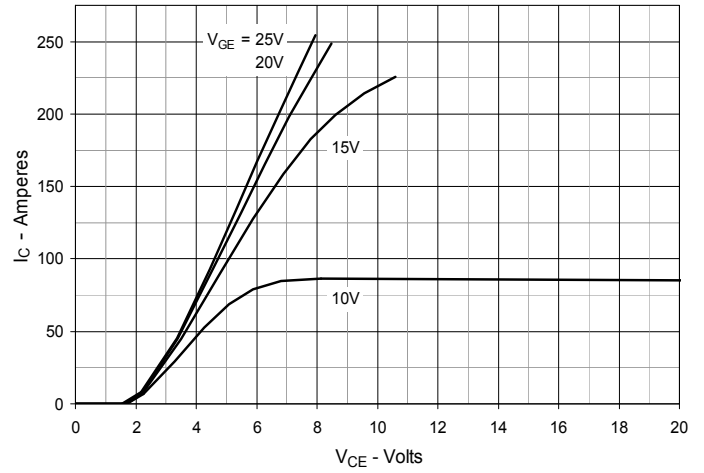
IXYS Reserves the Right to Change Limits, Test Conditions and Dimensions.

|  |           |           |           |           |              |              |              |              |              |             |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338B2 |
|  | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |             |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |             |

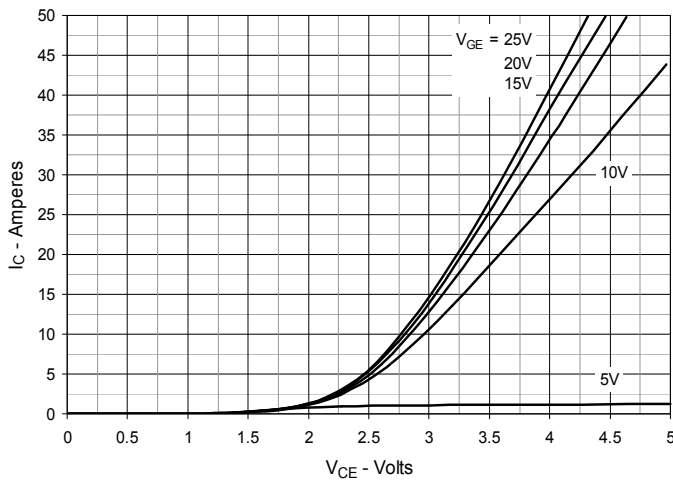
**Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$**



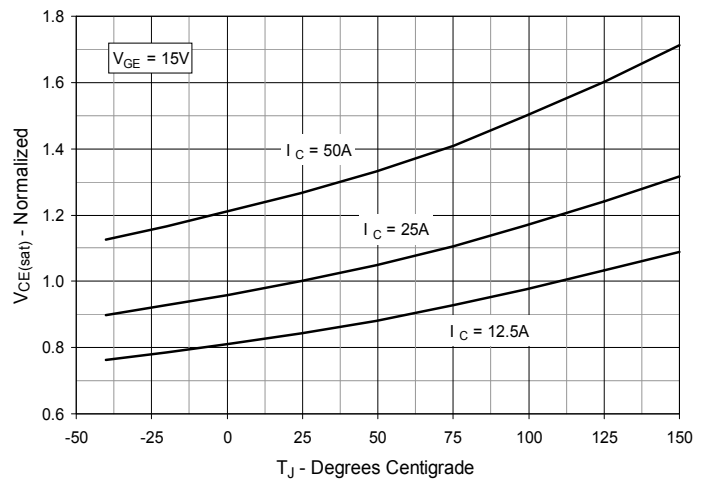
**Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$**



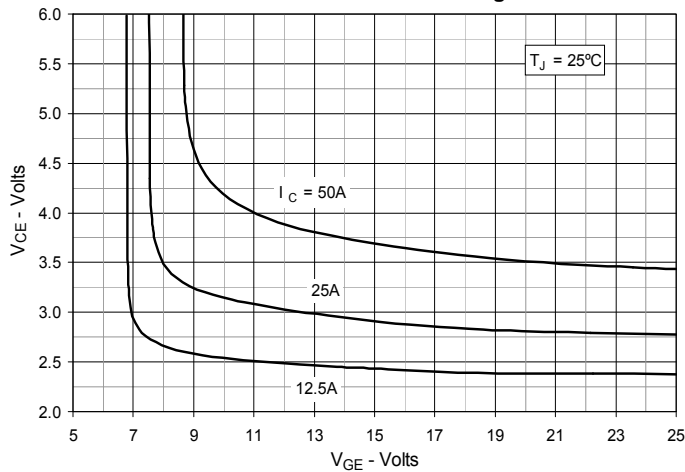
**Fig. 3. Output Characteristics @  $T_J = 125^\circ\text{C}$**



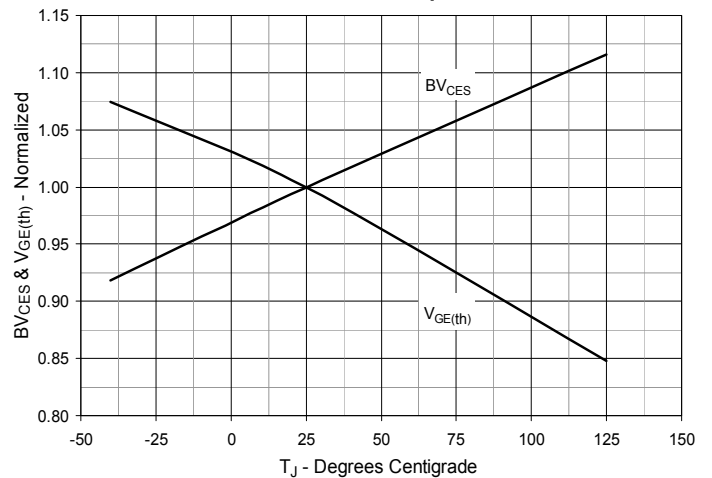
**Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature**

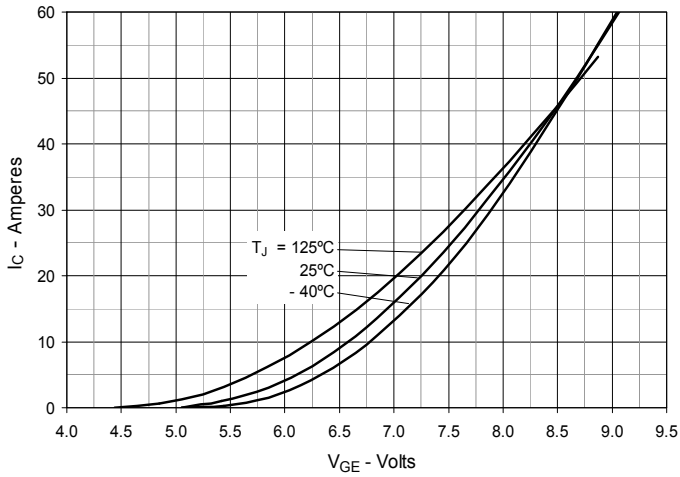
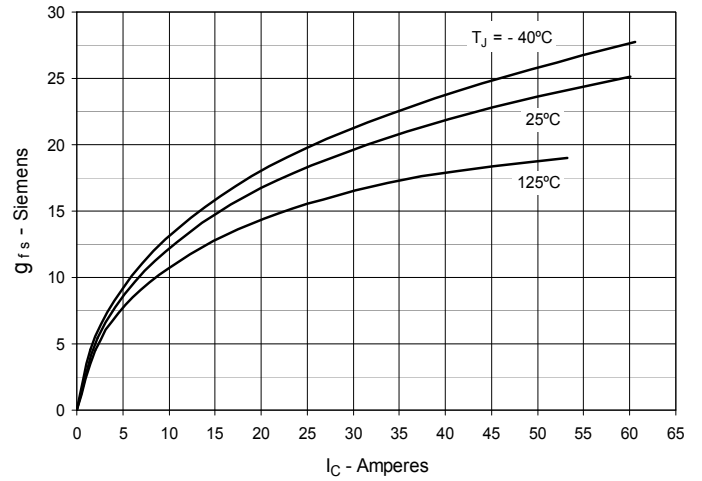
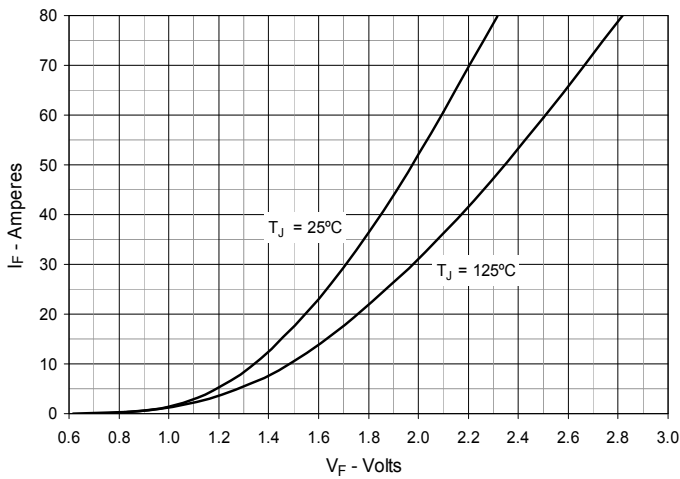
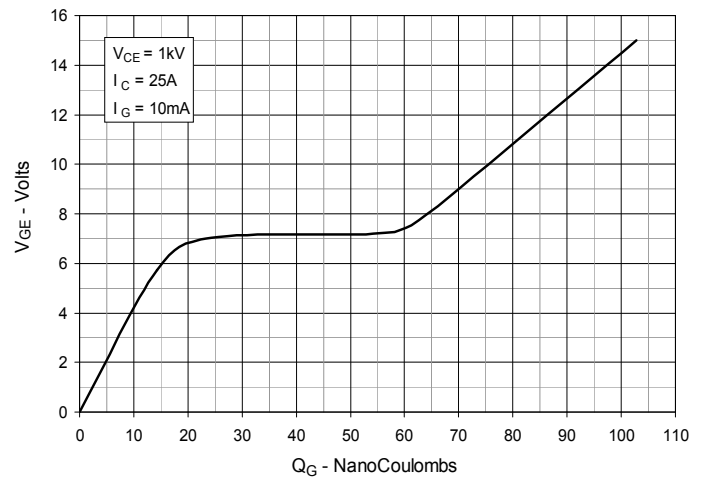
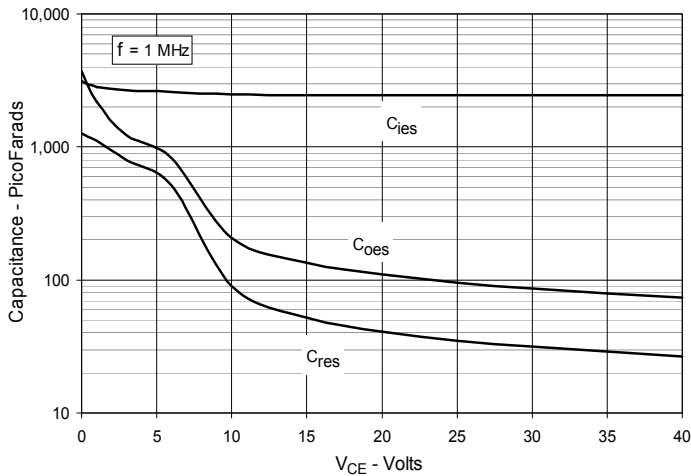
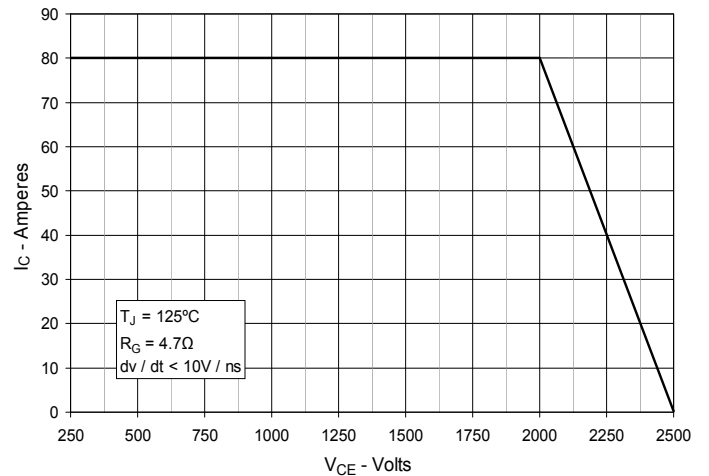


**Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage**



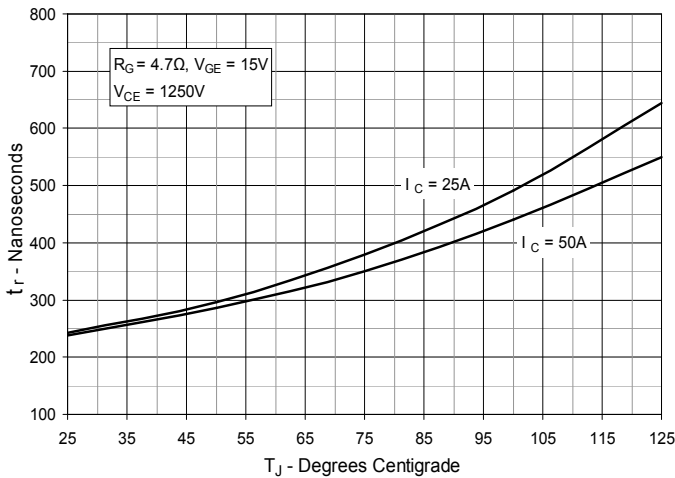
**Fig. 6. Breakdown & Threshold Voltages vs. Junction Temperature**



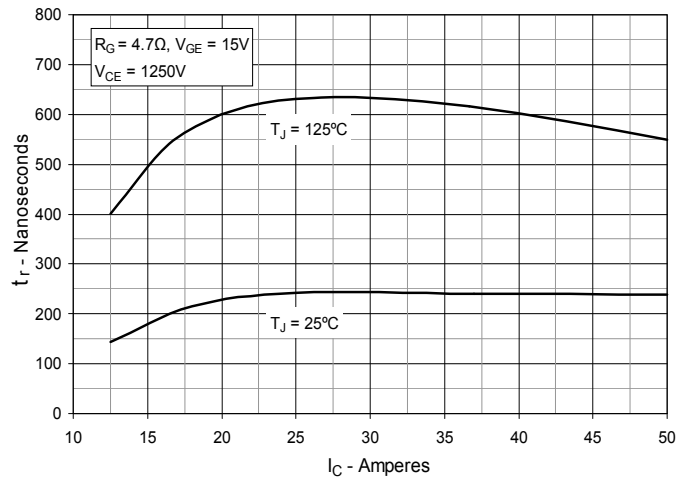
**Fig. 7. Input Admittance**

**Fig. 8. Transconductance**

**Fig. 9. Forward Voltage Drop of Intrinsic Diode**

**Fig. 10. Gate Charge**

**Fig. 11. Capacitance**

**Fig. 12. Reverse-Bias Safe Operating Area**


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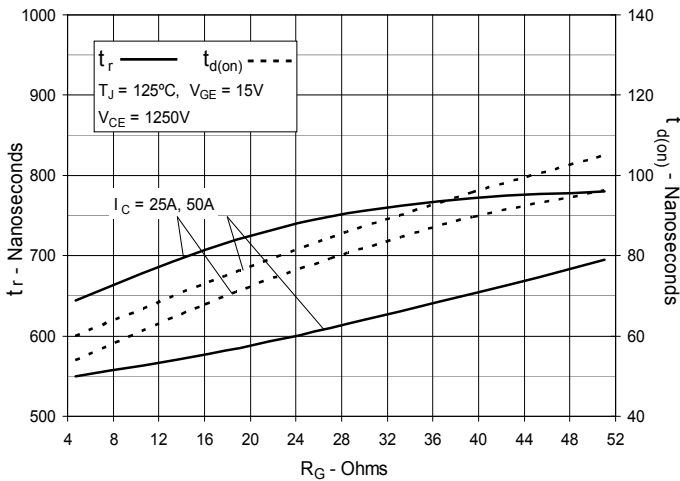
**Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature**



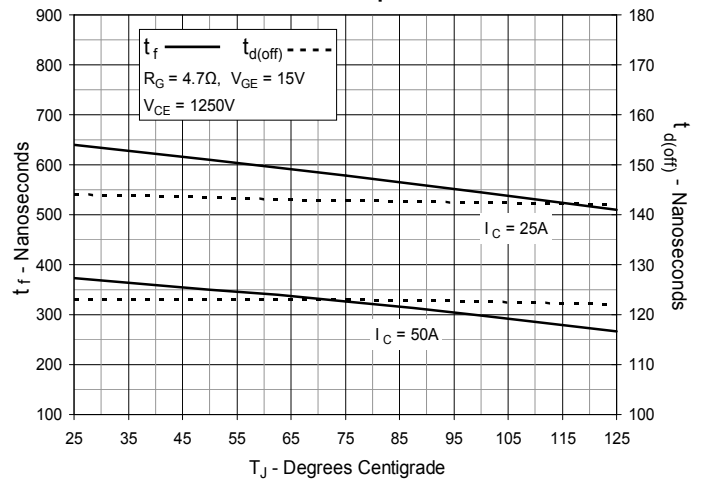
**Fig. 14. Resistive Turn-on Rise Time vs. Drain Current**



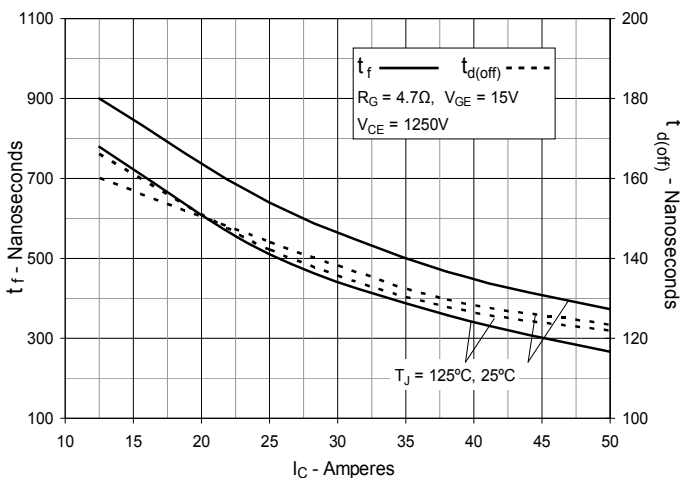
**Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance**



**Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature**



**Fig. 17. Resistive Turn-off Switching Times vs. Drain Current**



**Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance**

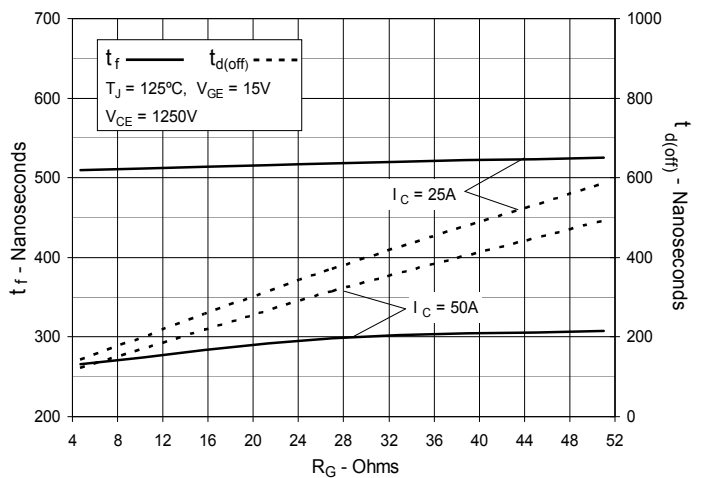


Fig. 19. Maximum Transient Thermal Impedance

